

5th Summer School on INtelligent signal processing for FrontIEr Research
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**FE4 2.5D AND 3D TECHNOLOGY: INTRODUCTION
TO 3D INTERCONNECT TECHNOLOGY DESIGN**

Monday, 13 May 2019 14:15 (9 minutes)

See abstract in LABS TABLE

Presenter: Dr PATTI, Robert (President of Nanced Semiconductors, USA)

Session Classification: LAB SESSION